

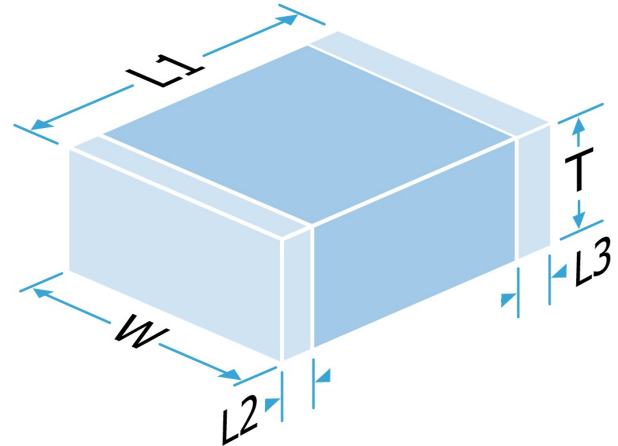
Multilayer Ceramic Chip Capacitor

Part Number: CDR32BX103BKZM

Description: 1206 100Vdc 10nF $\pm 10\%$ X7R (2X1) BX - Contains Lead

The MIL-PRF-55681 qualified parts range refers to ceramic capacitors that meet the rigorous standards set forth by the qualifying activity (DLA). This range is designed for use in military and aerospace applications, where high reliability, performance, and environmental endurance are critical.

MIL-PRF-55681 qualified ceramic capacitors are manufactured using advanced ceramic materials and production techniques that meet or exceed military standards. The construction ensures minimal failure rates, even under the most challenging operational conditions.



Mechanical Specification

Size Code	1206
Length (L1) in mm (")	3.2 ± 0.20 (0.126 ± 0.008)
Width (W) in mm (")	1.6 ± 0.20 (0.063 ± 0.008)
Thickness (T) in mm (")	1.3 Max (0.051 Max)
Minimum Termination Band (L2,L3) in mm (")	0.25 (0.010)
Maximum Termination Band (L2,L3) in mm (")	0.75 (0.030)
Termination Material	Nickel Barrier, Sn/Pb Plated Solder (Min 10% Lead, non RoHS)
Solderability	Per MIL-STD-202, Method 208
Packaging	Tape and Reel, 2500 per reel

General Electrical Specification

Rated Voltage	100Vdc
Nominal Capacitance Value	10nF
Capacitance Tolerance	$\pm 10\%$
Tangent of Loss Angle (Tan δ)	≤ 0.025
Capacitance and Tan δ Test Conditions	1.0Vrms @ 1kHz
Voltage Proof	250Vdc
(Voltage applied for 5 secs max. @ 50mA max. charge current. 50% Max, RH)	
Min Insulation Resistance (IR)	100.00GOhm @ 100Vdc
Dielectric Classification	X7R (2X1) BX - Contains Lead
Rated Temperature Range	-55°C / +125°C
Maximum Capacitance Change over Temperature Range	No DC Voltage $\pm 15\%$ Rated DC Voltage +15% / -25%
Climatic Category (IEC)	-
Ageing Characteristic	<2% per decade (nominal capacitance is 1000 hour value)

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This datasheet is for a standard item and is confirmed valid on the date generated, the latest published data for this part may differ and is available at <http://www.knowlescapacitors.com> or by contacting us.

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Data is correct to the best of our knowledge, errors and omissions excepted.

Date: Friday, October 24, 2025

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Description: 1206 100Vdc 10nF $\pm 10\%$ X7R (2X1) BX - Contains Lead

Environmental

RoHS Compliant to 2011/65/EC as amended by 2015/863/EU

Non Compliant

REACH Compliant

Contains 1 to 8% w/w Lead Titanium Oxide (PbTiO₃, CAS 12060-00-3) and 0.1 to 1.0% w/w Lead (Pb, CAS 7439-92-1)

California Proposition 65

Risk of exposure to lead (CAS 7439-92-1)

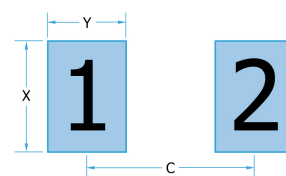
Board Layout

Knowles' conventional 2-terminal chip capacitors can generally be mounted using pad designs in accordance with international specification IPC-7351, Generic Requirements for Surface Mount Design and Land Pattern Standards, but there are some other factors that have been shown to reduce mechanical stress, such as reducing the pad width to less than the chip width. In addition, the position of the chip on the board should be considered.

Some high voltage parts may require modifications to the board layout and/or the addition of a conformal coating to prevent flashover, especially under high humidity conditions. Board cleanliness and environmental conditions can also impact this. Refer to application note AN0043 for further information.

IPC-7351 pad design

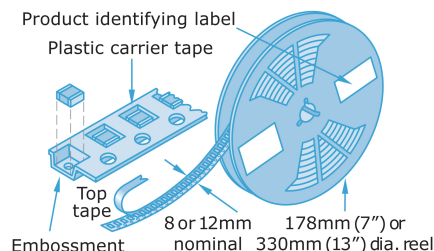
	1206	
C	3.00mm	0.118"
Y	1.15mm	0.045"
X	1.80mm	0.071"



Packaging

Tape packaging information for tape-and-reel parts:

Tape and reel packing of surface mounting chip capacitors for automatic placement are in accordance with IEC60286-3.



Soldering

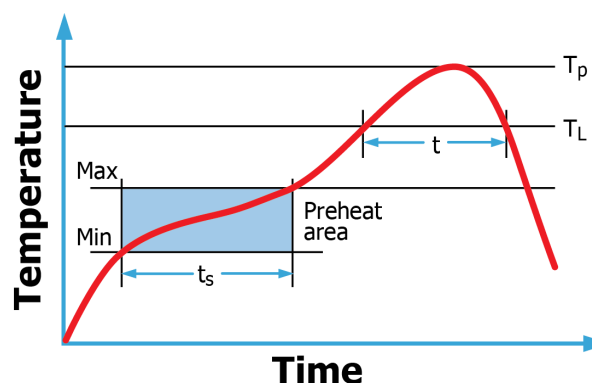
Reflow solder in accordance with IPC-A-610. Recommended reflow profile as laid down in IPC/JEDEC J-STD-020.

Wave soldering is also possible, but care must be taken for case sizes 1210 and larger and component thickness >1.0mm. Trials are encouraged.

Hand soldering is not recommended and can lead to component damage through thermal shock.

PdAg terminations are primarily intended for conductive epoxy attachment - they may be suitable for soldering but trials are recommended.

Application notes with mounting and handling guidance are available on request.



Complex

DLI

Johanson MFG

Novacap

Syfer

Voltronics

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